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MINIMUM MATING HEIGHT (SEE NOTE 2)	ĸ
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MATING PROFILE	
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TAINLESS STEEL AP: LCP UL94, V-0 COLOR BLACK CONDUCTIVE COPPER ALLOY ACTS: 0.75 MICRON MIN GOLD OVER 1.27 MICRON MIN NICKEL 3.18 MICRON MIN SILVER OVER 1.27 MICRON MIN NICKEL TANDARD PIN DRAWINGS: /ING 2032633080-SD, MIN. MATING DISTANCE 7.32MM DRAWING 2032630001-SD, MIN. MATING DISTANCE 7.67MM OUNT DRAWING 2032634185-SD, MIN. MATING DISTANCE 7.77MM CATION: 2043130001-PS IFICATION: 2043130001-AS. SPEC FOR SOLDERING INFORMATION. FICATION: 2043650000-PK	E
ITS WILL BE SUPPLIED TARNISH FREE OVER TIME. AP TO BE REMOVED AFTER SOLDERING.	
OOUT OF BOTTOM FROM THE TOP. LASER MARKED APPROXIMATELY WHERE SHOWN MAT	
ON THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION ENT REV DESC: UPDATED THE TITLE BLOCK	C
0: 747243 N: SACHIK7 D: SCS02 D: SCS02 D: HTHYAGARA L 2023/04/26 D: SCS02 D: SCS02 D	B
AL REVISION: N: NVELUSAMY 2019/01/24 2019/04/05 DOCUMENT NUMBER DOC TYPE DOC PART REVISION PSD 000 B2	
ANGLE PROJECTION DRAWING SERIES MATERIAL NUMBER CUSTOMER SHEET NUMBER D-SIZE 212195 2121950010 GENERAL MARKET 1 OF 1	A